Editor's Note

The articles in this issue by Yao, Tzou and Zhong, Chen and Cheung, Williams and Kennedy, Low et al., Li et al., and To and Li were presented in an earlier form at the International Conference on Vibration Engineering, Tsinghua University, Beijing, China, in June 1994. These articles were selected, edited, and reviewed by a committee chaired by:

Professor Z.C. Zheng Department of Engineering Mechanics Tsinghua University

The conference chairman was:

H.C. Hu President of the Chinese Society for Vibration Engineering